onsemi

MOSFET – N-Channel, POWERTRENCH®

100 V, 80 A, 6.4 m Ω

FDWS86068-F085

Features

- Typ $R_{DS(on)} = 5.2 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typ $Q_{g(tot)} = 31 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- Qualified to AEC Q101
- Wettable flanks for automatic optical inspection (AOI)
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Steering

MOSFET MAXIMUM RATINGS (T_A = 25°C, Unless otherwise specified)

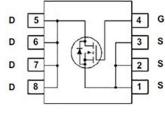
Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain to Source Voltage	100	V
V _{GS}	Gate to Source Voltage	±20	V
ID	Drain Current (T _C = 25°C) Continuous (V _{GS} = 10 V) (Note 1) Pulsed	80 (see Fig. 4)	A
E _{AS}	Single Pulse Avalanche Energy (Note 2)	36	mJ
PD	Power Dissipation Derate above 25°C	214 1.43	W W/°C
T _J , T _{STG}	Operating and Storage Temperature	–55 to +150	°C
$R_{\theta JC}$	Thermal Resistance (Junction to case)	0.7	°C/W
$R_{ heta JA}$	Maximum Thermal Resistance (Junction to Ambient) (Note 3)	50	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

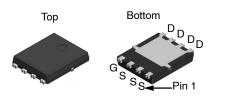
- 1. Current is limited by wirebond configuration.
- 2. Starting $T_J = 25^{\circ}$ C, $\dot{L} = 20 \,\mu$ H, $I_{AS} = 60$ A, $V_{DD} = 80$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in2 pad of 2oz copper.

V _{DSS}	I _D MAX	R _{DS(on)} MAX
100 V	80 A	6.4 mΩ

ELECTRICAL CONNECTION

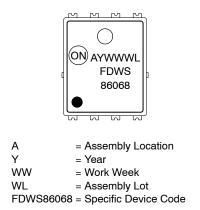






DFNW8 CASE 507AU

MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
FDWS86068-F085	DFNW8 (Power 56) (Pb–Free)	3000 / Tape & Reel

⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARAC	TERISTICS	•	•		•	
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	100	-	-	V
I _{DSS}	Drain to Source Leakage Current				1	μA mA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V	-	-	±100	nA
N CHARACT	ERISTICS	·				
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2	3	4	V
R _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 80 \text{ A}$ ($T_{J} = 25^{\circ}\text{C}$) ($T_{J} = 175^{\circ}\text{C}$) (Note 4)		5.2 11.4	6.4 14	mΩ
YNAMIC CH	ARACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$	-	2220	-	pF
C _{oss}	Output Capacitance	f = 1 MHZ	-	1350	-	pF
C _{rss}	Reverse Transfer Capacitance		-	19	-	pF
Rg	Gate Resistance	V _{GS} = 0.5 V, f = 1 MHz	-	0.3	-	Ω
Q _{g(tot)}	Total Gate Charge	V_{GS} = 0 $$ to 10 V, V_{DD} = 50 V, I_{D} = 80 A $$	-	31	43	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V, V_{DD} = 50 V, I_{D} = 80 A	-	4	-	nC
Q _{gs}	Gate to Source Gate Charge	V _{DD} = 50 V, I _D = 80 A	-	12	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	7	-	nC
WITCHING C	HARACTERISTICS					
t _{on}	Turn-On Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 80 \text{ A},$	-	-	30	ns
t _{d(on)}	Turn-On Delay Time	V _{GS} = 10 V, R _{GEN} = 6 Ω	-	15	-	ns
t _r	Turn-On Rise Time		-	6	-	ns
t _{d(off)}	Turn-Off Delay Time		-	24	-	ns
t _f	Turn-Off Fall Time		-	7	-	ns
t _{off}	Turn-Off Time		-	-	48	ns
RAIN-SOUR	CE DIODE CHARACTERISTICS					
V _{SD}	Source to Drain Diode Forward Voltage	$I_{SD} = 80 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	0.95	1.3	V
		$I_{SD} = 40 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	0.87	1.2	V
_						

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production

 I_F = 80 A, dI_{SD}/dt = 100 A/µs

61

56

80

84

ns

nC

Reverse Recovery Time

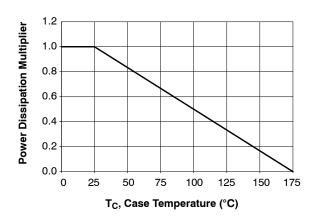
Reverse Recovery Charge

 T_{rr}

Q_{rr}

TYPICAL CHARACTERISTICS

(T_J = 25°C unless otherwise noted)





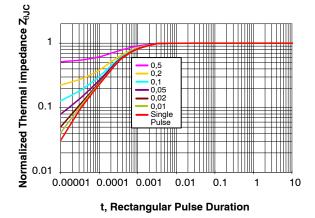


Figure 3. Normalized Maximum Transient Thermal Impedance

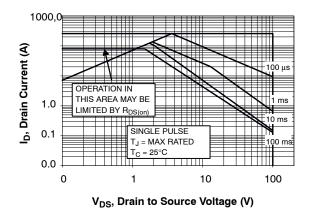


Figure 5. Forward Bias Safe Operating Area

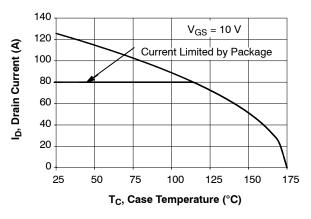


Figure 2. Maximum Continuous Drain Current vs. Case Temperature

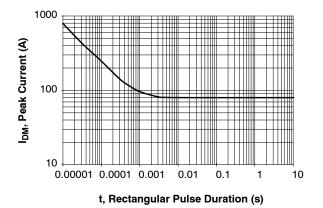


Figure 4. Peak Current Capability

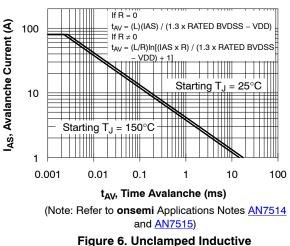
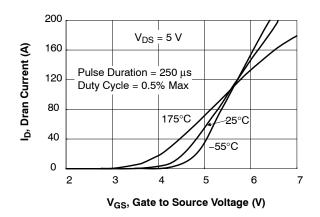


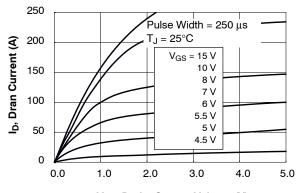
Figure 6. Unclamped Inductive Switching Capability

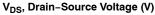
TYPICAL CHARACTERISTICS

(T_J = 25°C unless otherwise noted)











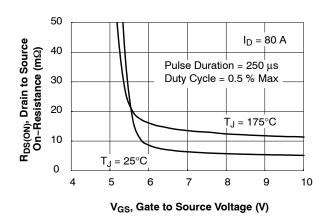


Figure 11. R_{DSON} vs. Gate Voltage

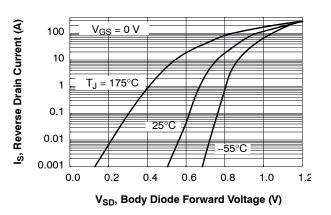


Figure 8. Forward Diode Characteristics

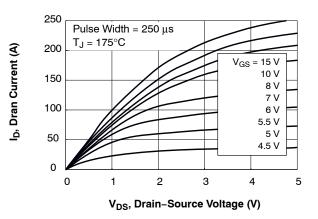
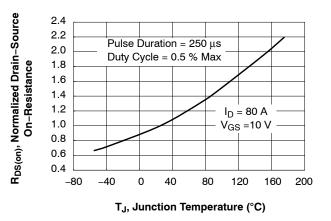


Figure 10. Peak Current Capability





TYPICAL CHARACTERISTICS

(T_J = 25°C unless otherwise noted)

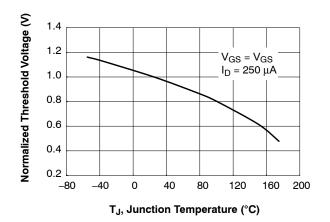


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

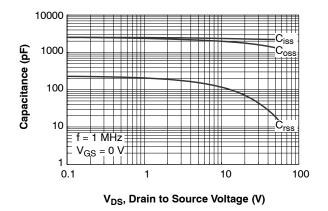


Figure 15. Capacitance vs. Drain to Source Voltage

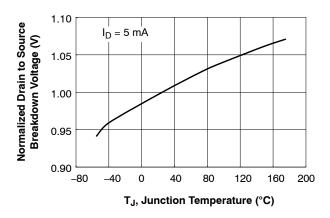


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

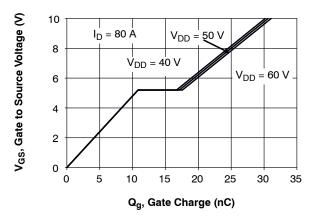


Figure 16. Gate Charge vs. Gate to Source Voltage

PACKAGE DIMENSIONS

DFNW8 5.2x6.3, 1.27P CASE 507AU **ISSUE A**

> (5.10) 4.42

DIM

MIN.

0.90

0.65

0.47

0.13

5.00

4.80

3.72

6.20

5.70

3.38

1.30

0.64

0.24

0°

3.91

1.27

5

网

0.92

1 22-

MILLIMETERS

NOM.

1.00

0.75

0.30 REF

0.52

0.18

(0.54)

5.10

4.90

3.82

6.30

5.80

3.48

0.30 REF

0.45 REF

1.27 BSC

0.635BSC

1.40

0.74

0.29

(0.28)

MAX.

1.10

0.05

0.85

0.57

0.23

5.20

5.00

3.92

6.40

5.90

3.58

1.50

0.84

0.34

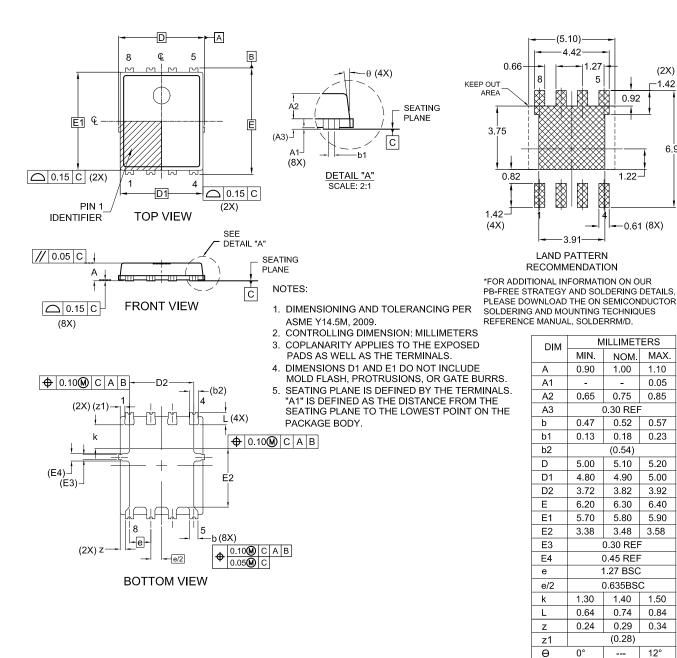
12°

-0.61 (8X)

(2X)

-1.42

6.91



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